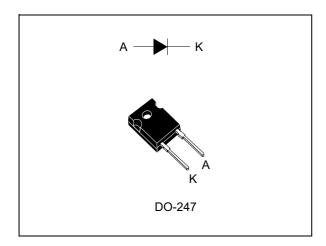


STTH30ACS06W

Turbo 2 ultrafast high voltage rectifier

Datasheet - production data



Features

- Ultrafast switching
- · Low reverse current
- · Low thermal resistance
- Reduces switching and conduction losses

Description

The STTH30ACS06W, which is ST Turbo 2 600 V technology, is suited as boost diode especially in air conditioning equipment for continuous mode interleaved power factor correction.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V_{RRM}	600 V
T _j (max)	175 °C
V _F (typ)	1.45 V
t _{rr} (max)	30 ns

Characteristics STTH30ACS06W

1 Characteristics

Table 2. Absolute ratings (limiting values at $T_i = 25$ °C, unless otherwise specified)

	,	•	•	•
Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage	600	V	
I _{F(RMS)}	RMS forward current 50 A			
I _{F(AV)}	Average forward current	30	Α	
I _{FSM}	Surge non repetitive forward current	190	Α	
T _{stg}	Storage temperature range		-65 to +175	°C
Tj	Maximum operating junction temperature	+175	°C	

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case	1.2	°C/W	

Table 4. Static electrical characteristics

Symbol	Parameter	Test cond	litions	Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V - V	-		5	μA
'R`	Neverse leakage current	T _j = 150 °C	$V_R = V_{RRM}$	-	30	300	μΑ
V _E ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _E = 30 A	-		2.4	V
ν _E , ,	Porward voltage drop	T _j = 150 °C	IF = 30 A	-	1.45	1.9	V

- 1. Pulse test: t_p = 5 ms, δ < 2%
- 2. Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.42 \text{ x I}_{F(AV)} + 0.016 \text{ x I}_{F^2(RMS)}^2$$

Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
			$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_R = 1 \text{ A}$			30	ns
t _{rr}	Reverse recovery time	T _j = 25 °C	$I_F = 1 \text{ A}, V_R = 30 \text{ V},$ $dI_F/dt = -50 \text{ A/}\mu\text{s}$		40	55	ns
I _{RM}	Reverse recovery current	T _j = 125 °C	$I_F = 30 \text{ A,d}I_F/dt = 200 \text{ A/}\mu\text{s},$ $V_R = 400 \text{ V}$		7.8	10.5	Α
t _{fr}	Forward recovery time	T _i = 25 °C	$I_F = 30 \text{ A,dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s},$			300	ns
V _{FP}	Forward recovery voltage	1 _j = 23 C	V _{FR} = 2.8 V		3.5		V

STTH30ACS06W Characteristics

Figure 1. Average forward power dissipation versus average forward current $\mathsf{P}_{\mathsf{F}(\mathsf{AV})}(\mathsf{W})$ 80 70 60 50 40 30 20 10 0 10 15 25 30 35 40

Figure 3. Forward voltage drop versus forward current (maximum values)

1000.0

100.0

100.0

10.0

10.0

10.0

10.0

10.0

1.8

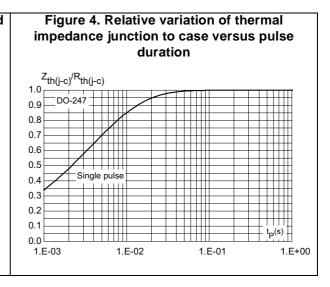
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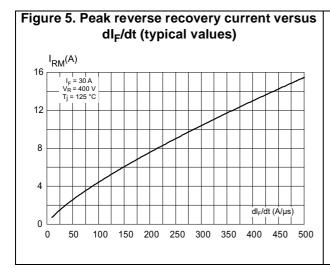
3.0

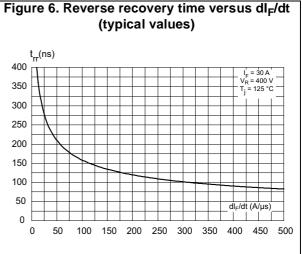
3.6

4.2

1.2







0.1

0.0

0.6

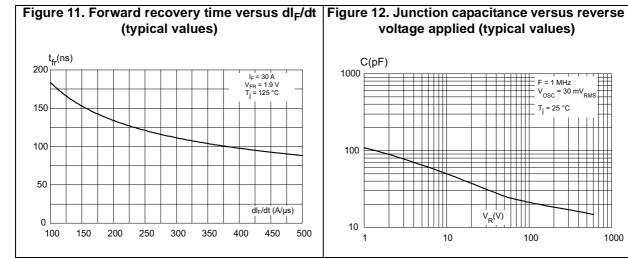
Characteristics STTH30ACS06W

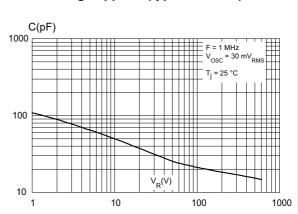
Figure 7. Reverse recovery charges versus dl_F/dt (typical values) $Q_{rr}(nC)$ 900 I_E = 30 V 800 700 600 500 400 300 200 100 dl_F/dt (A/µs)_ 0 0 100 150 200 250 300 350 400 450 500

Figure 8. Softness factor versus dl_F/dt (typical values) S_{factor} 4.0 I_F = 30 V _F = 30 V -V_R = 400 V T_j = 125 °C 3.0 2.0 1.0 dl_F/dt (A/µs) 0.0 150 200 250 300 350 400 450 500

Figure 9. Relative variations of dynamic parameters versus junction temperature 1.4 I_F = 30 V V_R = 400 V erence: T_j = 1 1.2 1.0 0.8 0.6 0.4 0.2 T_i(°C) 0.0 25 50 75 100 125

Figure 10. Transient peak forward voltage versus dl_E/dt (typical values) $V_{FP}(V)$ I_F = 30 A T_i = 125 °C 6 2 dl_F/dt (A/μs) 100 150 200 250 300 350 400 450 500





voltage applied (typical values)

Package information 2

- Epoxy meets UL94, V0
- Cooling method by conduction (C)
- Recommended torque value: 0.8 N·m
- Maximum torque value: 1.0 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 DO-247 package information

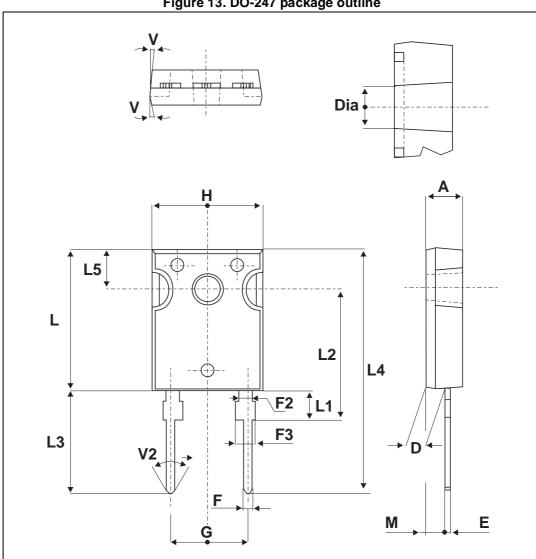


Figure 13. DO-247 package outline

Package information STTH30ACS06W

Table 6. DO-247 package mechanical data

			Dime	nsions			
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	4.85		5.15	0.191		0.203	
D	2.20		2.60	0.086		0.102	
E	0.40		0.80	0.015		0.031	
F	1.00		1.40	0.039		0.055	
F2		2.00			0.078		
F3	2.00		2.40	0.078		0.094	
G		10.90			0.429		
Н	15.45		15.75	0.608		0.620	
L	19.85		20.15	0.781		0.793	
L1	3.70		4.30	0.145		0.169	
L2		18.50			0.728		
L3	14.20		14.80	0.559		0.582	
L4		34.60			1.362		
L5		5.50			0.216		
М	2.00		3.00	0.078		0.118	
V		5°			5°		
V2		60°			60°		
Dia.	3.55		3.65	0.139		0.143	

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH30ACS06W	STTH30ACS06W	DO-247	1.8 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
22-Sep-2015	1	First issue.

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